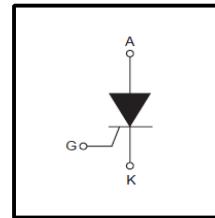


Sensitive Gate Silicon Controlled Rectifiers

Features

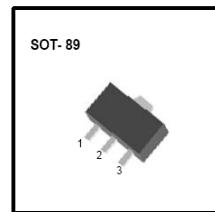
- Sensitive gate trigger current: $I_{GT}=200\mu A$ maximum
- Low on-state voltage: $V_{TM}=1.2$ (typ.)@ I_{TM}
- Low reverse and forward blocking current: $I_{DRM}/I_{PRM}=100\mu A$ @ $TC=125^{\circ}C$
- Low holding current: $I_H=5mA$ maximum



General Description

Sensitive triggering SCR is suitable for the application where gate current limited such as microcontrollers, logic integrated circuits, small motor control, gate driver for large SCR, sensing and detecting circuits.

General purpose switching and phase control applications



Absolute Maximum Ratings (Tj=25°C unless otherwise specified)

| Symbol | Parameter | Value | Units | |
|-------------------|---|-----------------------|--------------|----------------------|
| V_{DRM}/V_{RRM} | Repetitive peak off-state voltage | Note(1) | 400 | V |
| $I_{T(RMS)}$ | RMS on-state current (180° conduction angles) | $TJ=85^{\circ}C$ | 0.8 | A |
| $I_{T(AV)}$ | Average on-state current (80° conduction angles) | $TJ=85^{\circ}C$ | 0.5 | A |
| I_{TSM} | Non repetitive surge peak on-state current | $tp = 8.3 \text{ ms}$ | 9 | A |
| | | $tp = 10 \text{ ms}$ | 8 | |
| I^2t | I^2t Value for fusing | $tp = 8.3 \text{ ms}$ | 0.41 | A^2s |
| P_{GM} | Peak gate power | 2 | W | |
| dI/dt | Critical rate of rise of on-state current $I_{TM} = 2A$; $I_G = 10mA$; $dI_G/dt = 100mA/\mu s$ | $TJ=125^{\circ}C$ | 50 | $\text{A}/\mu s$ |
| $P_{G(AV)}$ | Average gate power dissipation | $TJ=125^{\circ}C$ | 0.1 | W |
| I_{FGM} | Peak gate current | $TJ=125^{\circ}C$ | 1 | A |
| V_{RGM} | Peak gate voltage | $TJ=125^{\circ}C$ | 5 | V |
| T_{J_1} | Junction temperature | - | $-40\sim125$ | °C |
| T_{stg} | Storage temperature | - | $-40\sim150$ | °C |

Note1: Although not recommended, off-state voltages up to 800 V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15 A/ μs .

Thermal Characteristics

| Symbol | Parameter | Value | | | Units |
|-----------|---|-------|-----|-----|-------|
| | | Min | Typ | Max | |
| R_{QJC} | Thermal resistance, Junction-to-Case | - | - | 60 | °C/W |
| R_{QJA} | Thermal resistance, Junction-to-Ambient | - | - | 150 | °C/W |

Electrical Characteristics ($T_J = 25^\circ\text{C}$, $R_{GK} = 1 \text{ k}\Omega$ unless otherwise specified)

| Symbol | Characteristics | | Min | Typ. | Max | Unit | |
|-------------------|---|-------------------------|-----------|------|-----|------------------------|------------------|
| I_{DRM}/I_{RRM} | off-state leakage current ($V_{AK} = V_{DRM}/V_{RRM}$) | $T_c=25^\circ\text{C}$ | - | - | 1 | μA | |
| | | $T_c=125^\circ\text{C}$ | | | 100 | | |
| V_{TM} | Forward "On" voltage ($I_{TM} = 1\text{A}$ $t_p = 380\mu\text{s}$) | | (Note2.1) | - | 1.2 | 1.7 | V |
| I_{GT} | Gate trigger current (continuous dc) ($V_{AK} = 7 \text{ Vdc}$, $R_L = 100 \Omega$) | | (Note2.2) | 15 | - | 200 | μA |
| V_{GT} | Gate Trigger Voltage (Continuous dc) ($V_{AK} = 7 \text{ Vdc}$, $R_L = 100 \Omega$) | | (Note2.2) | - | - | 0.8 | V |
| V_{GD} | Gate threshold Voltage | | (Note2.1) | 0.2 | - | - | V |
| dv/dt | Voltage Rate of Rise Off-State Voltage ($V_D=0.67V_{DRM}$;exponential waveform) | $T_J=125^\circ\text{C}$ | 500 | 800 | - | $\text{V}/\mu\text{s}$ | |
| | | Gate open circuit | | 25 | | | |
| I_H | Holding Current ($V_D = 12 \text{ V}$; $IGT = 0.5 \text{ mA}$) | | | - | 2 | 5 | mA |
| I_L | latching current ($V_D = 12 \text{ V}$; $IGT = 0.5 \text{ mA}$) | | | - | 2 | 6 | mA |
| R_d | Dynamic resistance | $T_J=125^\circ\text{C}$ | | - | - | 245 | $\text{m}\Omega$ |

Note 2.1 Pulse width≤1.0ms,duty cycle≤1%

2.2 R_{GK} current is not included in measurement.

Fig 1. Gate Characteristics

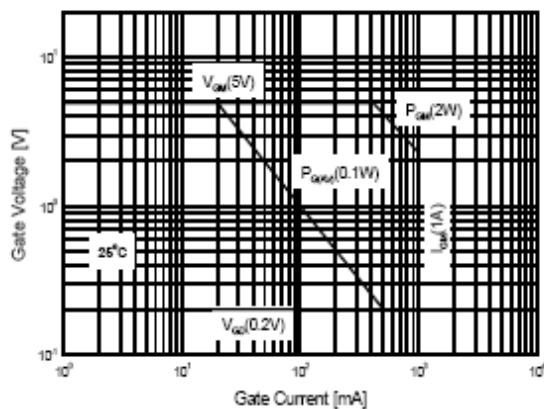


Fig 3. Typical Forward Voltage

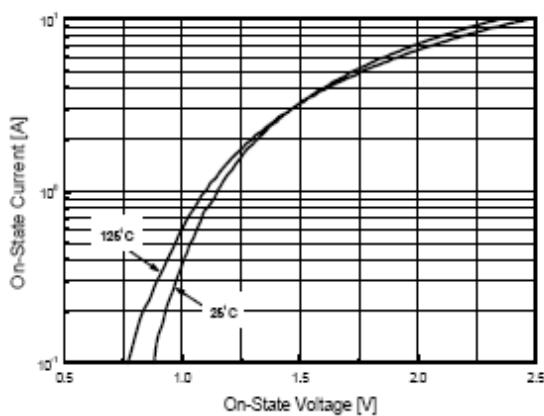


Fig 5. Typical Gate Trigger Voltage vs. Junction Temperature

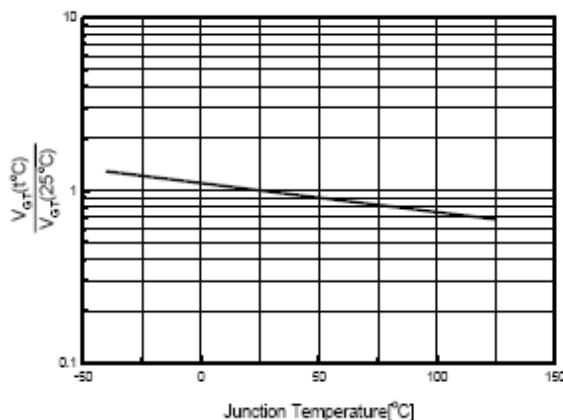


Fig 2. Maximum Case Temperature

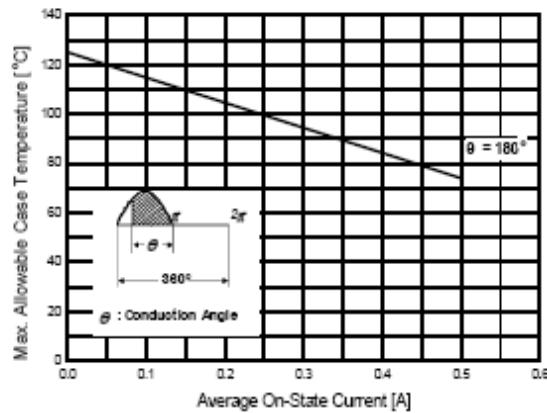


Fig 4. Thermal Response

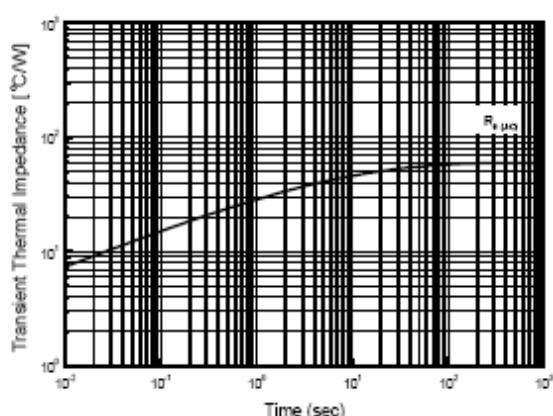


Fig 6. Typical Gate Trigger Current vs. Junction Temperature

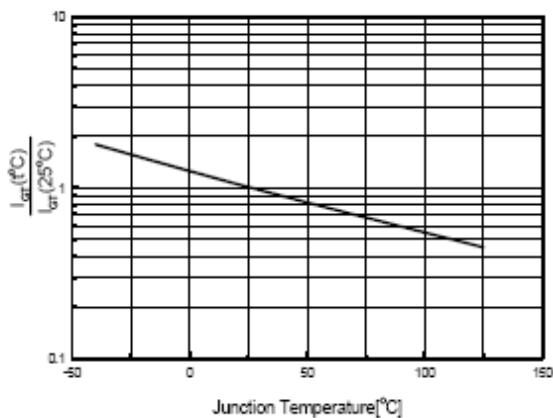


Fig 7. Typical Holding Current

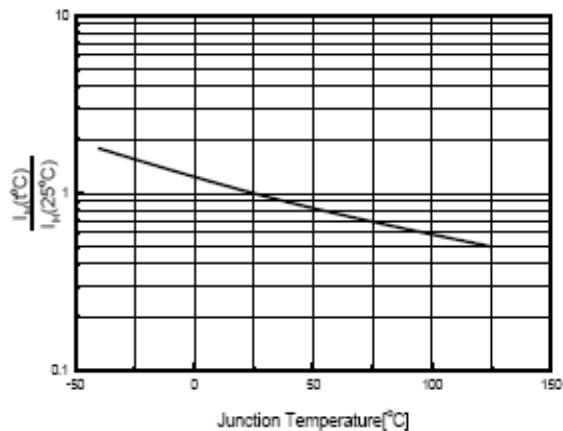
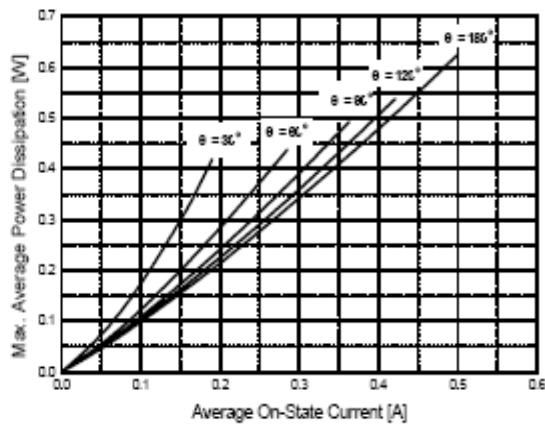


Fig 8. Power Dissipation



SPT-89 Package Dimension

| Dim. | mm | | | Inch | | |
|------|------|------|------|-------|-------|-------|
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 1.40 | | 1.60 | 0.055 | | 0.063 |
| B | 0.36 | | 0.56 | 0.014 | | 0.022 |
| B1 | 0.32 | | 0.52 | 0.013 | | 0.020 |
| C | 0.35 | | 0.44 | 0.014 | | 0.017 |
| C1 | 0.35 | | 0.44 | 0.014 | | 0.017 |
| D | 4.40 | | 4.60 | 0.173 | | 0.181 |
| D1 | 1.40 | | 1.80 | 0.055 | | 0.071 |
| E | 2.30 | | 2.60 | 0.091 | | 0.102 |
| e | | 1.50 | | | 0.060 | |
| e1 | 2.90 | | 3.10 | 0.114 | | 0.122 |
| H | 3.94 | | 4.25 | 0.155 | | 0.167 |
| L | 0.90 | | 1.10 | 0.035 | | 0.043 |
| R | | 0.25 | | | 0.010 | |

